imall

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



GP2W1001YP

Features

- 1. Integrated package of light emitter and receiver. (10.0×4.4×H3.5 mm)
- 2. Low profile type (Height:3.5 mm)
- 3. Compliant with IrDA1.0 and IrDA1.1
- 4. Low voltage operation type (Supply voltage:2.4V to 5.5V)
- 5. Low dissipation current thanks to power down mode (Dissipation current at shut-doen mode:Max. $1\mu A$)
- 6. Applicable for reflow soldering
- 7. With shield case

Applications

- 1. Personal computers
- 2. Personal information tools

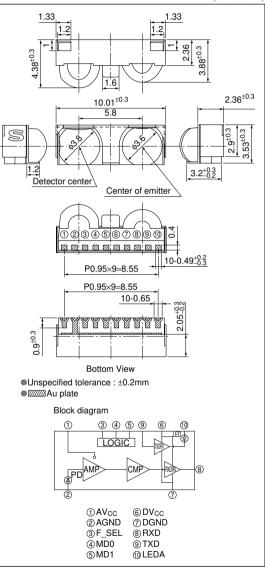
■ Absolute Maximum Ratings (Ta=25°C						
Parameter	Symbol	Rating	Unit			
Supply voltage	Vcc	6	V			
Transmission signal duty ratio	TXduty	50	%			
Operating temperature	Topr	-10 to +70	°C			
Storage temperature	Tstg	-20 to +85	°C			

Note) Transmission signal duty ratio show the time share of H level of transmission wave at TX terminal. The frequency shall be 1kHz or more.

Low Profile Type IrDA Transceiver Module Compliant with IrDA1.1

■ Outline Dimensions

(Unit : mm)



■ Recommended Operating Conditions (Ta=25°C)

Parameter	Symbol	Rating	Unit
Operating Supply voltage	Vcc	2.7 to 5.5	V
Operating temperature	Topr	0 to +70	°C
SIR bit rate	-	9.6 to 115.2	kbps
FIR bit rate	-	1.152/4	Mbps

■ Electro-optical Characteristics (Ta=25±3°C, Vcc=3.3±0.1V, 5±0.1V, Ambient illuminance of detecting face: 1001x or less)

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
_	Dissipation current at no input signal		Icc	RXOUT:H, TXIN:L, Vcc=3.3V	-	-	1.2	mA
			Icc	RXOUT:H, TXIN:L, Vcc=5.0V		_	1.5	mA
	S/D dissipation current		Iccs	RXOUT:H, TXIN:L, Vcc=3.3V	-	0.1	1	μΑ
				RXOUT:H, TXIN:L, Vcc=5.0V	-	0.2	2	μA
	Dissipation current	nt	Iccp	Peak Value, Vcc=3.3V (2.4Ω), 5.0V (6.8Ω)	-	400	600	mA
	Switching time (Shut dow	wn to stand by)	trsd		-	-	1.5	ms
	Receiver sensitivi	ty	Srx0	SIR:9.6k to 115.2kbps	0.04	-	5 000	W/m ²
	(-15	°≤θ≤+15°)	Srxθ	FIR:1.152M/4Mbps	0.01	-	5 000	W/m ²
ide	Low level output	voltage	Vol	Vcc=3.3, 5.0V	-	-	0.4	V
ers	High level output	voltage	Vон	Vcc=3.3, 5.0V	Vcc-0.4	-	-	V
Receiver side	Rise time		trrA	SIR:9.6k to 115.2kbps	-	-	200	ns
Rec	Rise time		trrB	FIR:1.152M/4Mbps	-	-	40	ns
	Fall time		tfrA	SIR:9.6k to 115.2kbps	-	-	200	ns
	r'an unic		t frB	FIR:1.152M/4Mbps	-	-	40	ns
	Peak sensitivity w	vavelength	λrx		-	940	-	nm
			tw1	SIR:Pulse width 19.53µs(9.6kbps), Duty 3/16	1	-	22	μs
			tw2	SIR:Pulse width 1.63µs(115.2kHz), Duty 3/16	1	_	3	μs
	Low level pules v	vidth	tw3	FIR:Pulse width 217ns(1.152Mbps), Duty 1/4	110	-	500	ns
			tw4	FIR:Pules width Single 125ns(4Mbps), Duty 1/4	85	-	165	ns
			tw5	FIR:Pules width Double 250ns(4Mbps), Duty 1/4	210	_	290	ns
	Peak emission wa	welength	λ_{tx}		850	880	900	nm
	Radiant intensity	ф=0°	Ielo	Low Power	-	15	-	mW/sr
e		ф=0°	Іемо	Middle Power	-	60	-	mW/sr
sid		-15°≤¢≤+15°	Iefθ	Full Power	100	-	500	mW/sr
itter	E Low level input voltage		VIL	Vcc=3.3, 5.0V	-	-	Vcc×0.2	V
smi	$\begin{array}{c c} \hline & & & \\ \hline \\ \hline$		VIH	Vcc=3.3, 5.0V	Vcc×0.2	-	-	V
lran	TXin terminal inp	out current	Ін	TXIN=Vcc=5.0V	-	-	50	μΑ
Ľ			IIL	TXIN=GND	-0.1	0	0.1	μΑ
	Transmission sign		trtx		-	-	40	ns
	Transmission sign	al fall time	t _{ftx}		-	-	40	ns

■ Truth Table

Inj	put	Output		
TXD (Transmitter)	*1 Receiver	State of LED (Transmitter)	RXD terminal	
High	-	ON	X	
Low	ON	OFF	Low	
Low	OFF	OFF	High	

X:Do not care

*1 External optical signal receiving state of photodiode

■ Input Output Logic Table

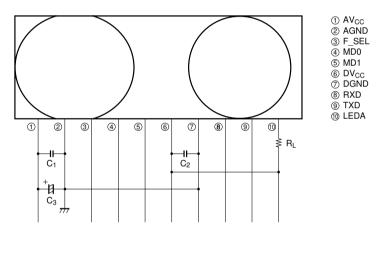
MD0	MD1	F_SEL	TXD	RXD terminal mode	TXO *2	Remarks
1	0	X	0	Shut down	Shut down	-
	0	1	0	RXA	Х	Latch TXD *1
	0	1	1	RXB	Х	Latch TXD ^{*1}
0	0	0	X	RXA	HPW	TXO Output High Power mode
0	1	0	X	\downarrow	MPW	TXO Output Middle Power mode
1	1	0	X	\downarrow	LPW	TXO Output Low Power mode
0	0	1	X	RXB	HPW	TXO Output High Power mode
0	1	1	X	\downarrow	MPW	TXO Output Middle Power mode
1	1	1	X	\downarrow	LPW	TXO Output Low Power mode

*1 F_SFL → 0:reset latching state of TXD, and turn to RXA channel. RXA:RXA channel mode:115kbps or less (SIR 115.2kbps, 9 600bps)

RXB:RXB channel mode:115kbps or more (FIR 1.152Mbps, 4Mbps)

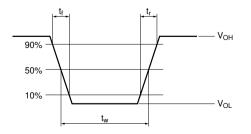
*2 LED operating mode

Fig.1 Recommended External Circuit



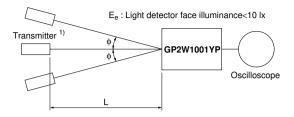
Components	Recommended values		
C1•C2	1µF±10% (Note 1)		
C ₃	4.7µF±10% (Note 2)		
	2.4Ω±5% 1/2W		
Р	(V _{CC} =3.3V)		
RL	6.8Ω±5% 1/2W		
	(V _{CC} =5V)		
(Note 1) Pleas	se locate nearby this		
trans	ceiver choosing the ceramic		
capa	citor with higher frequency		
featu	re		
(Note 2) Pleas	e choose the most suitable		
C _X ad	C _X according to the noise level		
and r	and noise frequency of power		
0.101			

Fig.2 Output Waveform Specification(Receiver side)(CL≤10pF)



SHARP

Fig.3 Standard Optical System(Receiver side)



Transfer rate	T ₁	T ₂	T_2/T_1	Radiant intensity
9.6kbps	104µs	19.53µs	3/16	40mW/sr
115.2kbps	8.68µs	1.63µs	3/16	40mW/sr
1.152Mbps	868ns	217ns	1/4	100mW/sr
4Mbps (S)	500ns	125ns	1/4	100mW/sr
4Mbps (W)	1 000ns	250ns	1/4	100mW/sr

 $\boldsymbol{\phi}$: Indicates horizontal and vertical directions.

The light emitting diode (SHARP GL710, λp =850 to 900nm) is used as the transmitter, where the following continuous signals are transmitted.

In Fig.3, output signal shall be complete receiver side electro-optical characteristics.

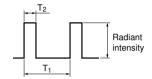


Fig.4 Output Waveform Specification(Transmitter side)

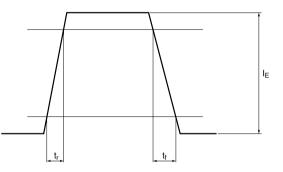


Fig.5 Standard Optical System(Transmitter side)

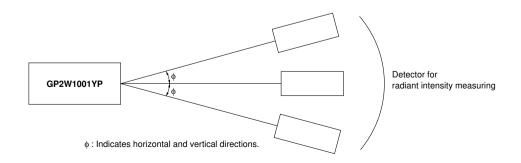


Fig.6 Recommended Circuit of Transmitter side

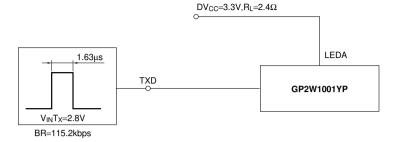


Fig.7 Peak Forward Current vs. Ambient Temperature

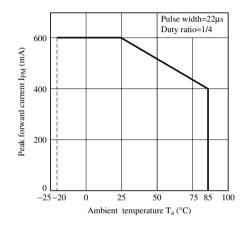


Fig.8 Recommended PCB Foot Pattern

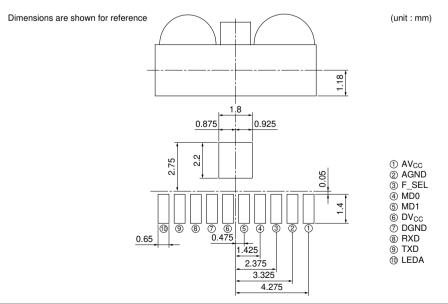
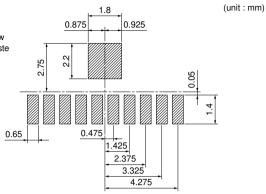


Fig.9 Recommended Size of Solder Creamed Paste (Reference)

Dimensions are shown for reference. Please open the solder mask as below so that the size of solder creamed paste for this device before reflow soldering must be as large as one of the foot pattern land indicated at Fig.8



Solder paste area

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